

### Features

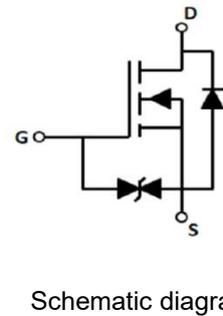
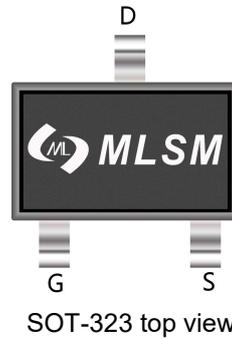
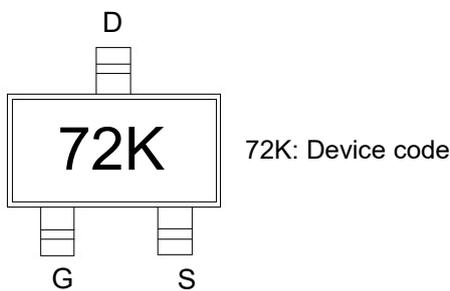
- High density cell design for Low  $R_{DS(on)}$
- Voltage controlled small signal switch
- Rugged and reliable
- High saturation current capability
- ESD protected

### Application

- Load Switch for Portable Devices
- DC/DC Converter

### Product Summary

$V_{DS}$	$R_{DS(on)}$ MAX	$I_D$ MAX
60V	2.5Ω@10V	0.34A
	3.0Ω@4.5V	



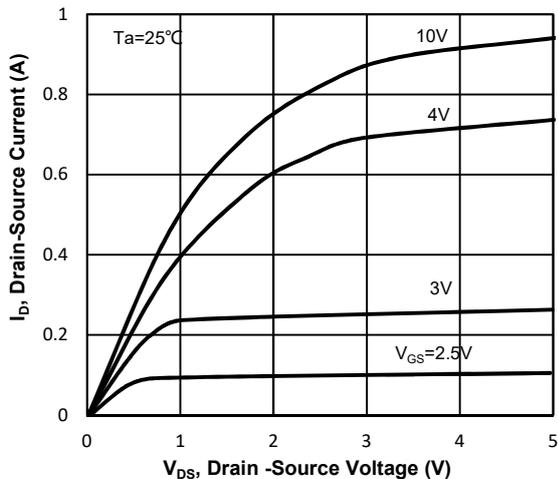
Marking and pin assignment

Absolute Maximum Ratings (TA=25°C unless otherwise noted)				
Symbol	Parameter		Rating	Unit
<b>Common Ratings (TC=25°C Unless Otherwise Noted)</b>				
$V_{DS}$	Drain-Source Breakdown Voltage		60	V
$V_{GS}$	Gate-Source Voltage		±20	V
$T_J$	Maximum Junction Temperature		150	°C
$T_{STG}$	Storage Temperature Range		-50 to 155	°C
$I_S$	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	0.34	A
<b>Mounted on Large Heat Sink</b>				
$I_{DM}$	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	1.2	A
$I_D$	Continuous Drain Current	$T_c=25^\circ\text{C}$	0.34	A
$P_D$	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	0.2	W
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient		625	°C/W

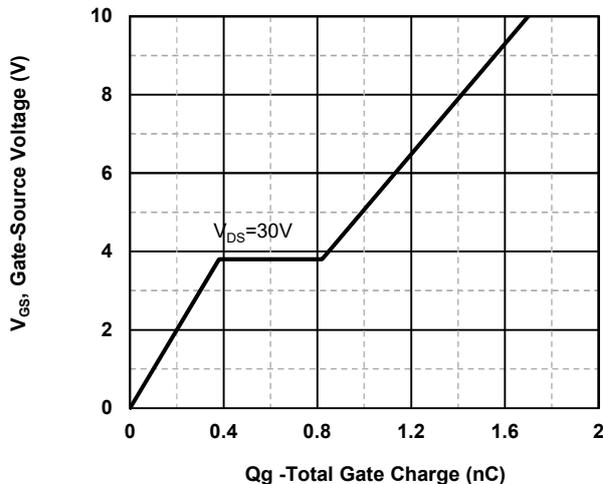
Ordering Information (Example)						
Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
2N7002KW	SOT-323	72K	3,000	45,000	180,000	7" reel

Electrical Characteristics (T <sub>J</sub> =25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
<b>Static Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
BV <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V	--	--	1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±10	μA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.0	1.6	2.5	V
R <sub>DS(on)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =0.5A	--	1.6	2.5	Ω
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =0.2A	--	2.1	3.0	Ω
<b>Dynamic Electrical Characteristics @ T<sub>J</sub> = 25°C (unless otherwise stated)</b>						
C <sub>ISS</sub>	Input Capacitance	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f=1MHz	--	27	--	pF
C <sub>OSS</sub>	Output Capacitance		--	6	--	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance		--	4	--	pF
<b>Switching Characteristics</b>						
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =30V, I <sub>D</sub> =0.3A, V <sub>GS</sub> =10V	--	1.22	2.4	nC
Q <sub>gs</sub>	Gate-Source Charge		--	0.5	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	0.18	--	nC
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =30V, I <sub>D</sub> =0.2A, V <sub>GS</sub> =10V, R <sub>G</sub> =50Ω	--	7	--	nS
t <sub>r</sub>	Turn-on Rise Time		--	19	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	20	--	nS
t <sub>f</sub>	Turn-off fall Time		--	84	--	nS
<b>Source- Drain Diode Characteristics</b>						
V <sub>SD</sub>	Forward on voltage	T <sub>J</sub> =25°C, I <sub>S</sub> =0.34A	--	--	1.2	V

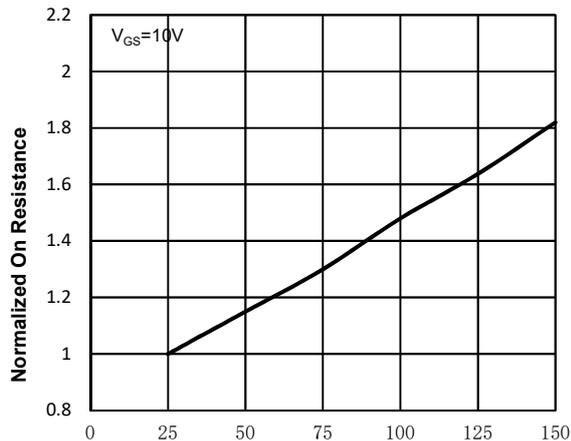
**Typical Operating Characteristics**



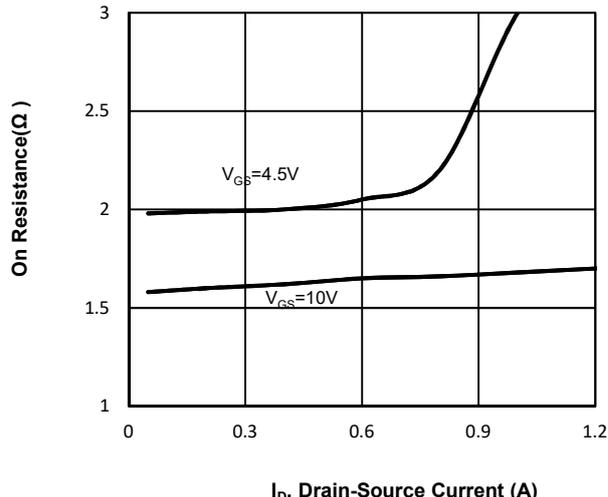
**Fig1. Typical Output Characteristics**



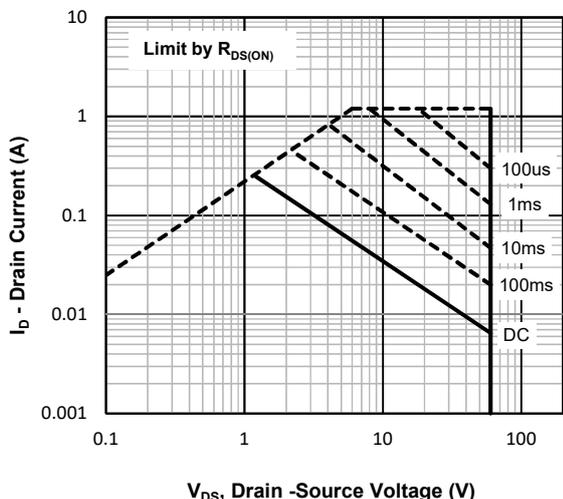
**Fig2. Typical Gate Charge Vs. Gate-Source Voltage**



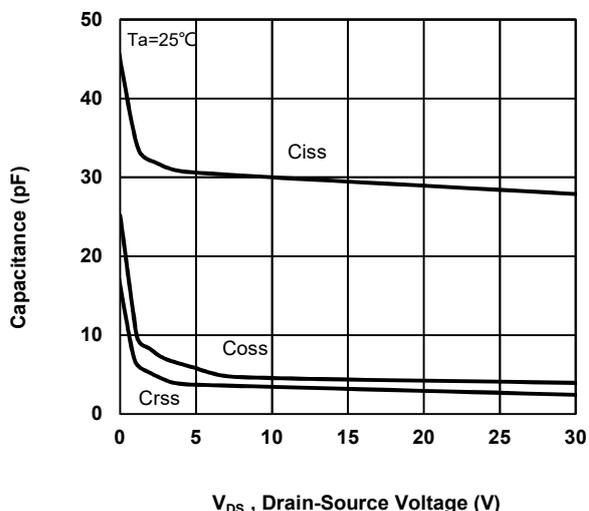
**Fig3. Normalized On-Resistance Vs. Temperature**



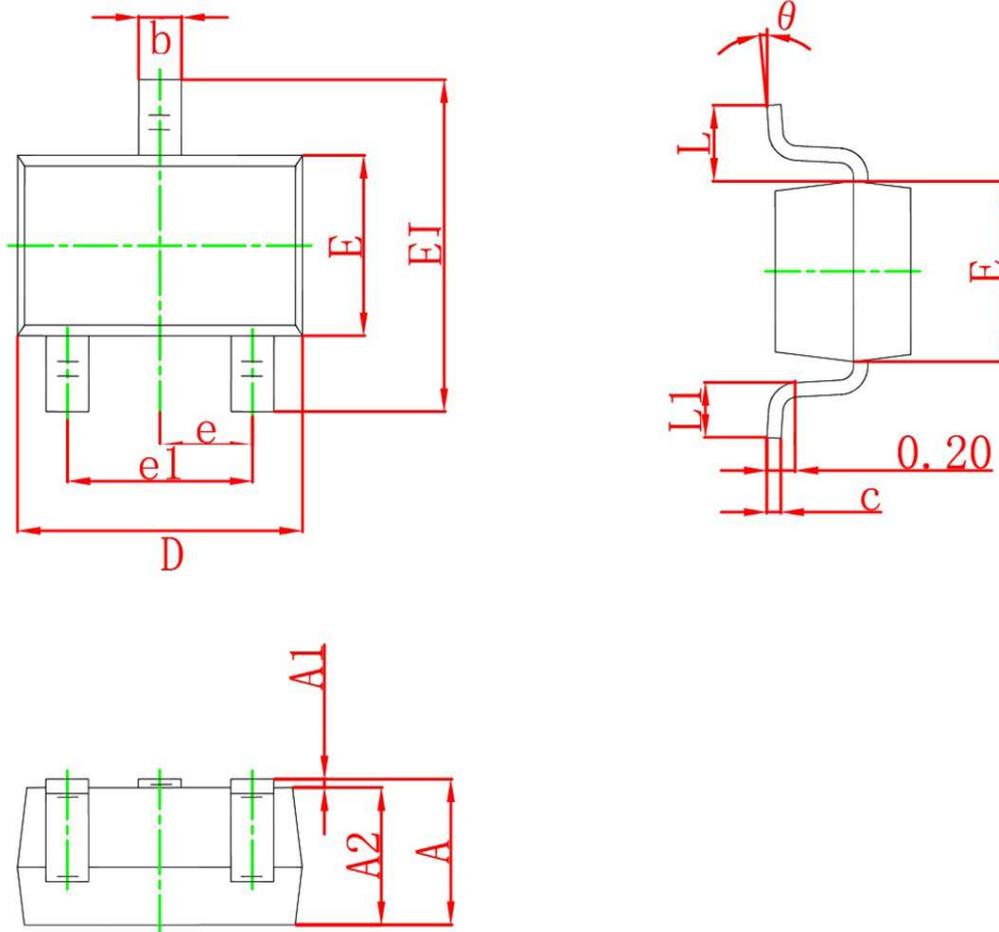
**Fig4. On-Resistance Vs. Drain-Source Current**



**Fig5. Maximum Safe Operating Area**



**Fig6. Typical Capacitance Vs. Drain-Source Voltage**

**SOT-323 Package information**


Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650TYP		0.026TYP	
e1	1.200	1.400	0.047	0.055
L	0.525REF		0.021REF	
L1	0.260	0.460	0.010	0.018
theta	0°	8°	0°	8°